PATENT ASSIGNMENT

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SUBMISSION TYPE:			NEW ASSIGNMENT	
NATURE OF CONVEYANCE:			ASSIGNMENT	
CONVEYING PARTY DATA				
Name				Execution Date
Patrick Blessing				06/11/2009
Ruedi Grueter				06/16/2009
Dominik Werne				06/16/2009
RECEIVING PARTY DATA				
Name:	ESEC AG			
Street Address:	Hinterbergstr. 32, Postfach 5503			
City:	Cham			
State/Country:	SWITZERLAND			
Postal Code:	СН-6330			
PROPERTY NUMBERS Total: 1				
Property Type			Number	
		25255		
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Email: mpizarro@nixonpeabody.com				
Correspondent Name: David B. Ritchie				
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ATTORNEY DOCKET NUMBER:			UF-P356USW (432633-072)	
NAME OF SUBMITTER:			David B. Ritchie	
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PATENT REEL: 025435 FRAME: 0633

PATENT REEL: 025435 FRAME: 0634

ASSIGNMENT

WHEREAS, we,

BLESSING Patrick, a citizen of Switzerland, residing at Seestr. 143b, CH-8800 Thalwil, Switzerland

GRUETER Ruedi, a citizen of Switzerland, residing at Sebaldematt 15,

CH-6018 Buttisholz, Switzerland

WERNE Dominik, a citizen of Germany, residing at Morgartenstr. 2

CH-6315 Oberaegeri, Switzerland

have invented an "Apparatus for mounting a flip chip on a substrate" for which we executed application papers for international patent application no.

PCT/EP2008/050841 which was filed on January 25, 2008; and on July 31, 2009, as serial no. 12/525,535; and

WHEREAS, ESEC AG, a Swiss corporation, having a place of business at Hinterbergstr. 32, Postfach 5503, CH-6330 Cham, Switzerland is desirous of acquiring the exclusive right, title and interest in and to said invention and in and to the Letters Patent to be granted and issued therefor in the United States of America and its territories and possessions;

NOW, THEREFORE, for a valuable consideration, the receipt of which is hereby acknowledged, we do sell, assign, transfer and set over unto said ESEC AG, its successors and assigns, the full and exclusive right, title and interest in and to said invention, including the right to claim priority, and in and to any and all Letters Patent to be granted and issued therefor and we hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said ESEC AG, its successors and assigns, in accordance with this Assignment.

WITNESS OUR HAND at Cham

Name: BLESSING Patrick

Date: 1. 06 200 9

Name: GRUETER Ruedi

Date:

Name: WERNE Dominik

Date:

ASSIGNMENT

WHEREAS, we,

BLESSING Patrick, a citizen of Switzerland, residing at Seestr. 143b, CH-8800 Thalwil, Switzerland GRUETER Ruedi, a citizen of Switzerland, residing at Sebaldematt 15, CH-6018 Buttisholz, Switzerland WERNE Dominik, a citizen of Germany, residing at Morgartenstr. 2 CH-6315 Oberaegeri, Switzerland

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WITNESS OUR HAND at Cham

Name: BLESSING Patrick

Date:

16.6.29

Name: GRUETER Ruedi

Date:

Name: WERNE Dominik

Date:

ASSIGNMENT

WHEREAS, we,

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WITNESS OUR HAND at Cham

Name: BLESSING Patrick

Date:

Name: GRUETER Ruedi

Date:

Jung

Name: WERNE Dominik

16.6.09 Date:

PATENT REEL: 025435 FRAME: 0637

RECORDED: 12/01/2010